

STQ1NE10L N-CHANNEL 100V - 0.3 Ω - 1A TO-92 STripFET[™] POWER MOSFET

TYPE	VDSS	R _{DS(on)}	ID
STQ1NE10L	100 V	<0.4 Ω	1 A

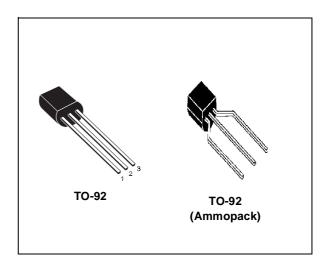
- TYPICAL $R_{DS}(on) = 0.3 \Omega$
- EXCEPTIONAL HIGH dv/dt CAPABILITY
- 100% AVALANCHE TESTED
- AVALANCHE RUGGED TECHNOLOGY
- LOW THRESHOLD DRIVE

DESCRIPTION

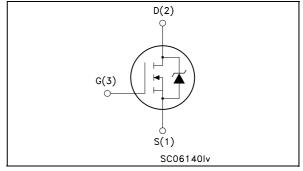
This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

APPLICATIONS

- DC MOTOR CONTROL (DISK DRIVES, etc.)
- DC-DC & DC-AC CONVERTERS
- SYNCHRONOUS RECTIFICATION



INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vds	Drain-source Voltage (V _{GS} = 0)	100	V
Vdgr	Drain-gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)	100	V
VGS	Gate- source Voltage	± 16	V
ID	Drain Current (continuous) at $T_C = 25^{\circ}C$	1	А
١D	Drain Current (continuous) at T _C = 100°C	0.6	А
I _{DM} (●)	Drain Current (pulsed)	4	А
Ptot ⁽¹⁾	Total Dissipation at $T_C = 25^{\circ}C$ 3		W
	Derating Factor	0.025	W/°C
dv/dt (2)	Peak Diode Recovery voltage slope	6	V/ns
Eas ⁽³⁾	Single Pulse Avalanche Energy	400	mJ
T _{stg}	Storage Temperature	-55 to 150	°C
T _j Operating Junction Temperature		-55 10 150	°C
) Pulse width limited by safe operating area. Related to Rthj -l		(2) I _{SD} ≤1A, di/dt ≤200A/µs, V _{DD} ≤ V _{(BR)DSS} , T _j : (3) Starting T _j = 25 °C, I _D = 1A, V _{DD} = 50V	≤ T _{JMAX}

December 2002

THERMAL DATA

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _(BR) DSS	Drain-source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0$	100			V
IDSS	Zero Gate Voltage Drain Current (V _{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating T _C = 125°C			1 10	μΑ μΑ
IGSS	Gate-body Leakage Current (V _{DS} = 0)	V _{GS} = ± 16 V			±100	nA

ON (*)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
VGS(th)	Gate Threshold Voltage	$V_{DS} = V_{GS}$	I _D = 250 μA	1		2.5	V
R _{DS(on)}	Static Drain-source On Resistance	V _{GS} = 10 V V _{GS} = 5 V	I _D = 0.5 A I _D = 0.5 A		0.30 0.35	0.40 0.45	Ω Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
9fs ^(*)	Forward Transconductance	V _{DS} = 15V I _D = 0.5	A	2		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25V f = 1 MHz V_{GS}$	0	345 45 20		pF pF pF

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ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on Time Rise Time			11 12		ns ns
Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	V _{DD} = 80 V I _D = 1 A V _{GS} = 5 V		7 1.5 3.5		nC nC nC

SWITCHING OFF

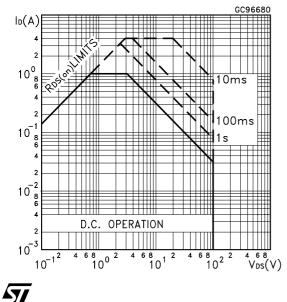
Syr	nbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
td	off) t _f	Turn-off Delay Time Fall Time		A	20 13		ns ns

SOURCE DRAIN DIODE

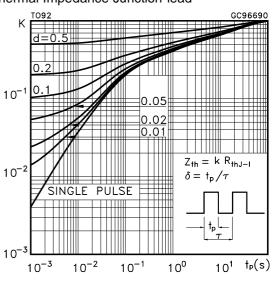
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} (●)	Source-drain Current Source-drain Current (pulsed)				1 4	A A
V _{SD} (*)	Forward On Voltage	I _{SD} = 1 A V _{GS} = 0			1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$\begin{split} I_{SD} &= 1 \ A & \text{di/dt} = 100 \text{A}/\mu\text{s} \\ V_{DD} &= 30 \ \text{V} & \text{T}_{j} = 150^{\circ}\text{C} \\ (\text{see test circuit, Figure 5}) \end{split}$		52 90 3.5		ns nC A

(*)Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %.
(•)Pulse width limited by safe operating area.

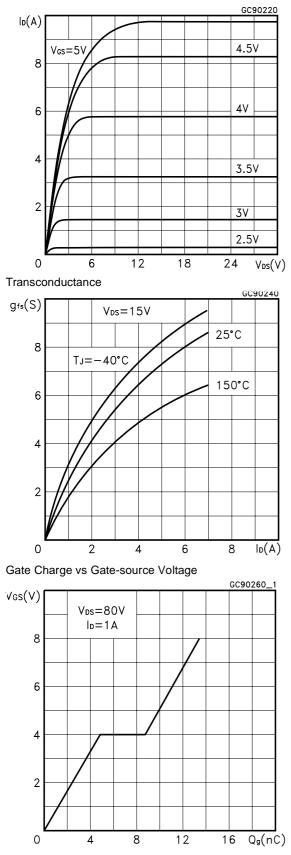
Safe Operating Area

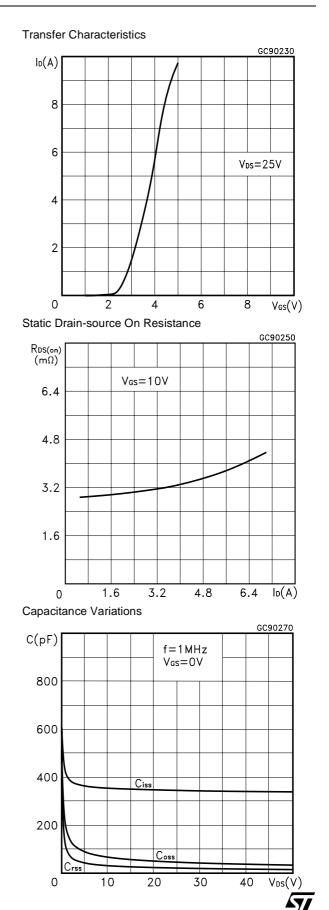


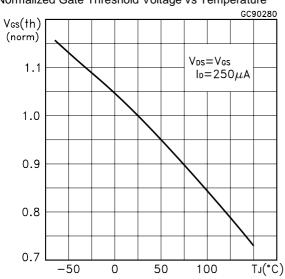
Thermal Impedance Junction-lead



Output Characteristics

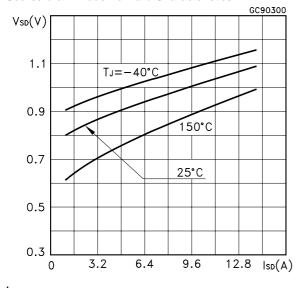




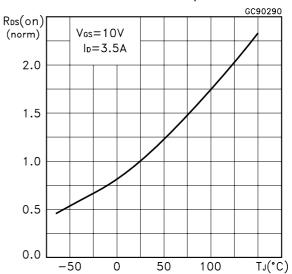


Normalized Gate Threshold Voltage vs Temperature

Source-drain Diode Forward Characteristics



Normalized on Resistance vs Temperature



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Fig. 1: Unclamped Inductive Load Test Circuit

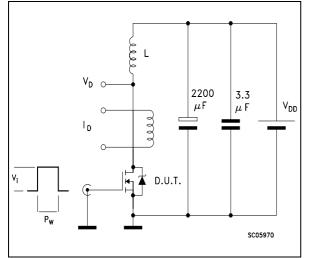


Fig. 3: Switching Times Test Circuits For Resistive Load

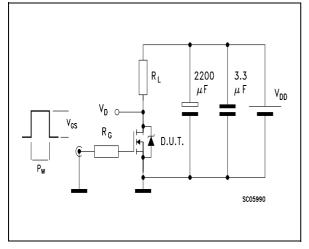


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

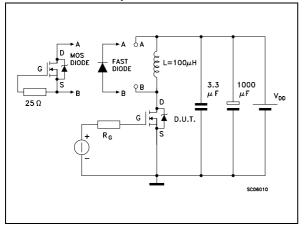


Fig. 2: Unclamped Inductive Waveform

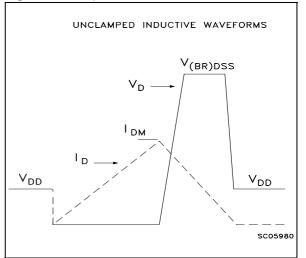
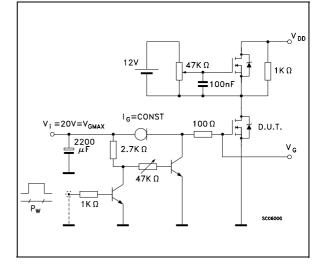


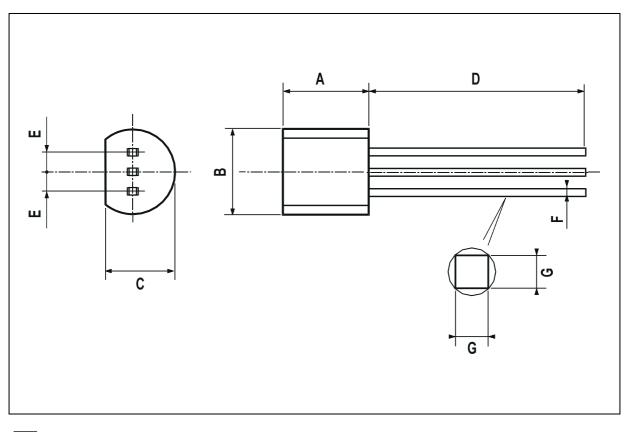
Fig. 4: Gate Charge test Circuit



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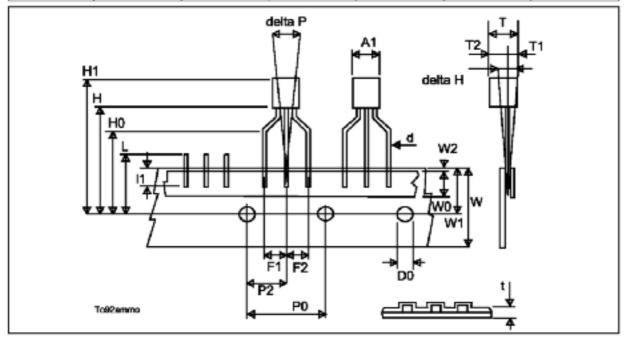
DIM.		mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
A	4.58		5.33	0.180		0.210	
В	4.45		5.2	0.175		0.204	
С	3.2		4.2	0.126		0.165	
D	12.7			0.500			
E		1.27			0.050		
F	0.4		0.51	0.016		0.020	
G	0.35			0.14			

TO-92 MECHANICAL DATA



TO-92 AMMOPACK

DIM		mm.		inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
A1			4.8			0.19	
Т			3.8			0.15	
T1			1.6			0.06	
T2			2.3			0.09	
d			0.48			0.02	
P0	12.5	12.7	12.9	0.49	0.5	0.51	
P2	5.65	6.35	7.05	0.22	0.25	0.27	
F1, F2	2.44	2.54	2.94	0.09	0.1	0.11	
delta H	-2		2	-0.08		0.08	
w	17.5	18	19	0.69	0.71	0.74	
W0	5.7	6	6.3	0.22	0.23	0.24	
W1	8.5	9	9.25	0.33	0.35	0.36	
W2			0.5			0.02	
н	18.5		20.5	0.72		0.80	
HO	15.5	16	16.5	0.61	0.63	0.65	
H1			25			0.98	
D0	3.8	4	4.2	0.15	0.157	0.16	
t			0.9			0.035	
L			11			0.43	
11	3			0.11			
delta P	-1		1	-0.04		0.04	



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